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## ROUND TYPE LED LAMPS

### LSE2640

## DATA SHEET

DOC. NO : QW0905-LSE2640

REV. : A

DATE : 11 - May - 2005



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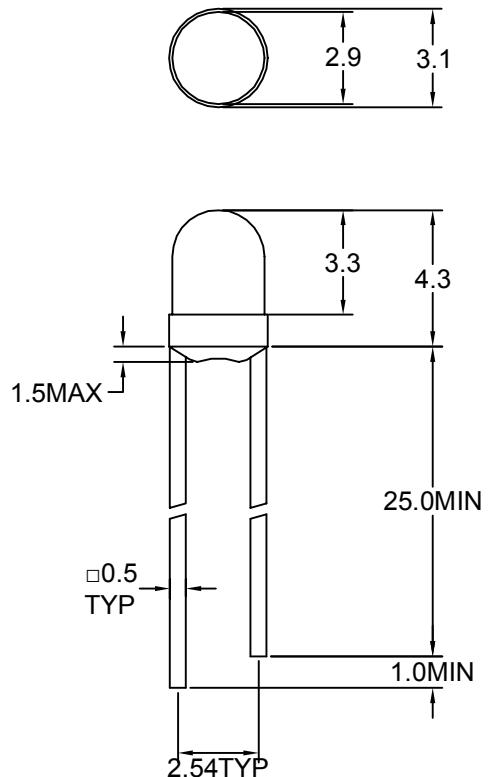
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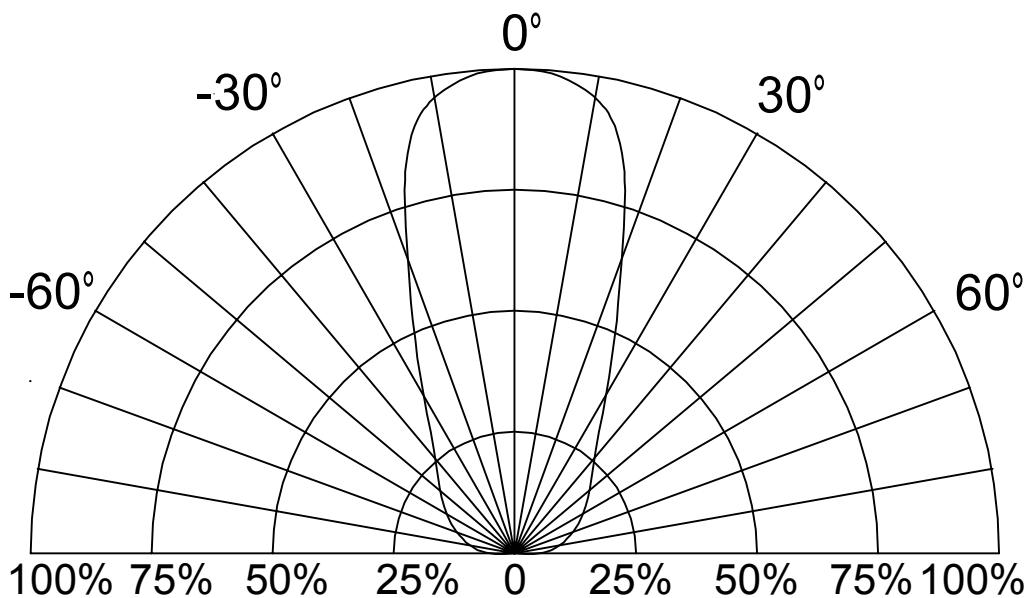
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### Package Dimensions



Note : 1.All dimension are in millimeter tolerance is  $\pm 0.25\text{mm}$  unless otherwise noted.  
2.Specifications are subject to change without notice.

### Directivity Radiation





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## Absolute Maximum Ratings at Ta=25

| Parameter                               | Symbol           | Ratings                                  |  | UNIT |
|---|------------------|--|--|------|
|   |                  | SE                                       |  |      |
| Forward Current                         | I <sub>F</sub>   | 20                                       |  | mA   |
| Peak Forward Current<br>Duty 1/10@10KHz | I <sub>FP</sub>  | 80                                       |  | mA   |
| Power Dissipation                       | PD               | 80                                       |  | mW   |
| Reverse Current @5V                     | I <sub>r</sub>   | 10                                       |  | μ A  |
| Operating Temperature                   | T <sub>opr</sub> | -40 ~ +85                                |  |      |
| Storage Temperature                     | T <sub>stg</sub> | -40 ~ +100                               |  |      |
| Soldering Temperature                   | T <sub>sol</sub> | Max 260 for 5 sec Max<br>(2mm from body) |  |      |

## Typical Electrical &amp; Optical Characteristics (Ta=25 )

| PART NO | MATERIAL  | COLOR   |                 | Peak wave length<br>Pnm | Spectral halfwidth<br>nm | Forward voltage<br>@20mA(V) |      | Luminous intensity<br>@10mA(mcd) |      | Viewing angle<br>2 1/2<br>(deg) |
|---------|-----------|---------|-----------------|-------------------------|--------------------------|-----------------------------|------|----------------------------------|------|---------------------------------|
|         |           | Emitted | Lens            |                         |                          | Min.                        | Max. | Min.                             | Typ. |                                 |
| LSE2640 | GaAsP/GaP | Orange  | Orange Diffused | 610                     | 45                       | 1.7                         | 2.6  | 4.5                              | 9.6  | 50                              |

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.

2. The luminous intensity data did not including ±15% testing tolerance.



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## Typical Electro-Optical Characteristics Curve

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Fig.1 Forward current vs. Forward Voltage

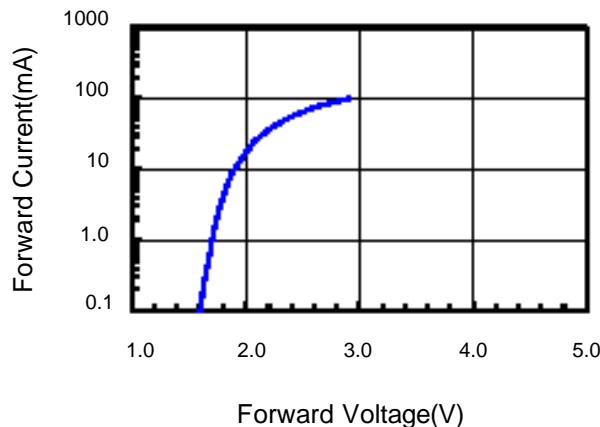


Fig.2 Relative Intensity vs. Forward Current

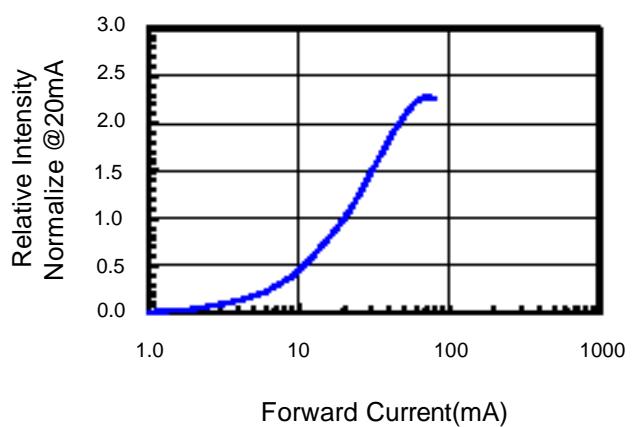


Fig.3 Forward Voltage vs. Temperature

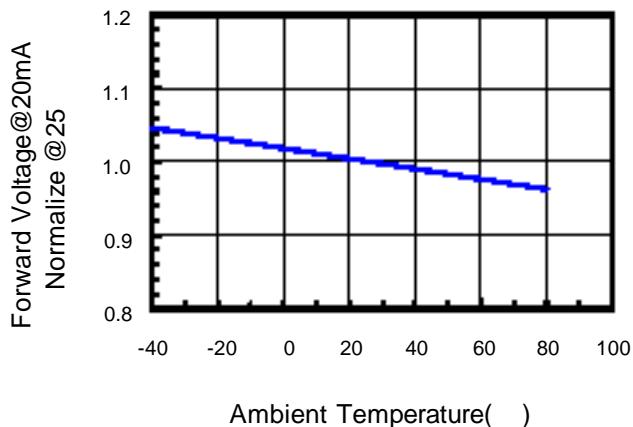


Fig.4 Relative Intensity vs. Temperature

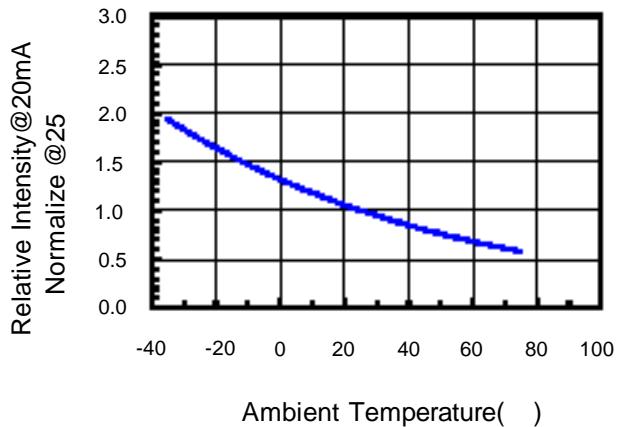
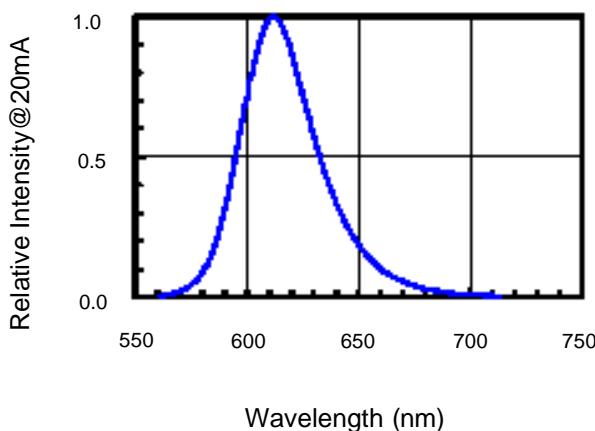


Fig.5 Relative Intensity vs. Wavelength



**Reliability Test:**

| Test Item                           | Test Condition   | Description   | Reference Standard   |
|-------------------------------------|--|---|--|
| Operating Life Test                 | 1.Under Room Temperature<br>2.If=20mA<br>3.t=1000 hrs (-24hrs, +72hrs) | This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed.  | MIL-STD-750: 1026<br>MIL-STD-883: 1005<br>JIS C 7021: B-1                      |
| High Temperature Storage Test       | 1.Ta=105 ±5<br>2.t=1000 hrs (-24hrs, +72hrs)                           | The purpose of this is the resistance of the device which is laid under condition of high temperature for hours.  | MIL-STD-883:1008<br>JIS C 7021: B-10   |
| Low Temperature Storage Test        | 1.Ta=-40 ±5<br>2.t=1000 hrs (-24hrs, +72hrs)                           | The purpose of this is the resistance of the device which is laid under condition of low temperature for hours.   | JIS C 7021: B-12   |
| High Temperature High Humidity Test | 1.Ta=65 ±5<br>2.RH=90 %~95 %<br>3.t=240hrs ±2hrs                       | The purpose of this test is the resistance of the device under tropical for hours.  | MIL-STD-202:103B<br>JIS C 7021: B-11   |
| Thermal Shock Test                  | 1.Ta=105 ±5 &-40 ±5<br>(10min) (10min)<br>2.total 10 cycles            | The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature.  | MIL-STD-202: 107D<br>MIL-STD-750: 1051<br>MIL-STD-883: 1011                    |
| Solder Resistance Test              | 1.T.Sol=260 ±5<br>2.Dwell time= 10 ±1sec.                              | This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire. | MIL-STD-202: 210A<br>MIL-STD-750: 2031<br>JIS C 7021: A-1                      |
| Solderability Test                  | 1.T.Sol=230 ±5<br>2.Dwell time=5 ±1sec                                 | This test intended to see soldering well performed or not.  | MIL-STD-202: 208D<br>MIL-STD-750: 2026<br>MIL-STD-883: 2003<br>JIS C 7021: A-2 |